

Transient Voltage Suppressor

Features

- IEC 61000-4-2(ESD) $\pm 30\text{KV}$ (air), $\pm 30\text{KV}$ (contact)
- IEC61000-4-5(Lightning) 8A (8/20 μS)
- 150Watts peak pulse power (tp=8/20 μS)
- Low operating voltage and low clamping
- Moisture sensitivity level: Level 1
- Small package:SOD523
- AEC-Q101 qualified

Exterior



SOD523

Application information

- High Speed Line:USB1.0/2.0,VGA
- Audio
- Control signal port

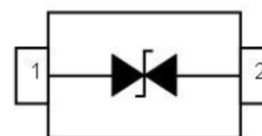
Package (top view)



Agency Approvals

Icon	Description
RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003
	Mean lead free

Schematic Symbol



Part Number and Electrical Parameter

Part Number	$I_{\text{DRM}}@V_{\text{DRM}}$		$V_{\text{BR}}^{①}@I_{\text{R}}$		$V_{\text{C}}@I_{\text{pp}}^{②}$		$V_{\text{C}}@I_{\text{pp}}^{②}$		$C_{\text{O}}^{③}$
	μA	V	V	mA	V	A	V	A	pF
	MAX		MIN		MAX		MAX		MAX
BV-D505ZCQ	0.1	5.0	5.6	1	11.6	5.0	19.0	8.0	15.0

Absolute maximum ratings measured at $T = 25^{\circ}\text{C}$ RH = 45%-75% (unless otherwise noted).

① V_{BR} is measured at $I_{\text{R}}=1\text{mA}$

② Surge Waveform: 8/20 μS .

③ Off-state capacitance is measured in $V_{\text{DC}}=0\text{V}$, $f=1\text{MHz}$

Transient Voltage Suppressor

Part Numbering System

BV D5 05 Z C Q
(1) (2) (3) (4) (5) (6)

(1) Bencent Transient Voltage Suppressor

(2) Package: SOD523

(3) Stand-off Voltage: 5V

(4) Normal Capacitance

(5) Bidirectional

(6) AEC-Q101 qualified

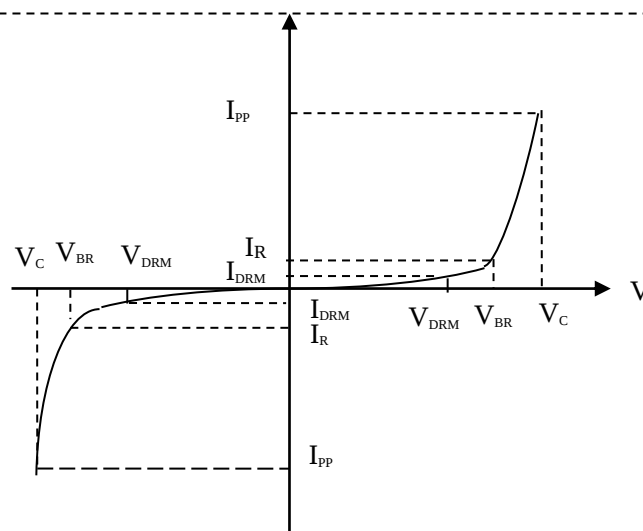
Mark



5C∞: Part Number

V-I Curve

Parameters	Definition
V_C	Clamping voltage
I_{PP}	Peak pulse current
V_{DRM}	Stand-off Voltage
V_{BR}	Breakdown Voltage
I_{DRM}	Reverse Leakage Current
I_R	Test current
P_{pp}	Peak Pulse Power Dissipation



Thermal Considerations

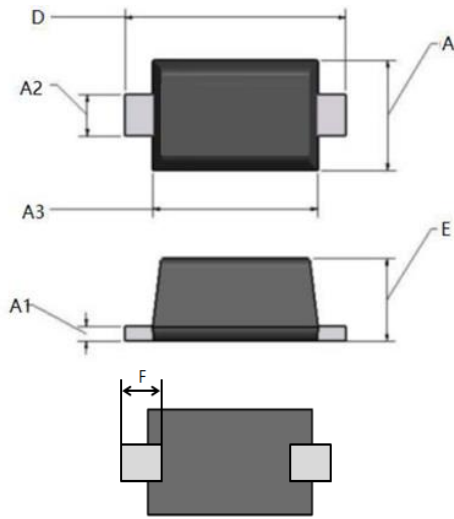
symbol	Parameter	Value	Unit
T_J	Operating Junction Temperature Range	-40 to +150	°C
T_S	Storage Temperature Range	-40 to +150	°C

Environmental Characteristics

Testing items	Technical standards
High temperature Reverse Bias Test	Temperature: $150 \pm 3^\circ\text{C}$ Bias= $80\%V_{DRM}$ Time:168H
High Temperature Life Test	Temperature: 150°C Time:168H
High-low Temperature Cycle test	Temperature: From -40°C to 125°C Dwell time : 30min,100cycles
High Temperature &High Humidity Test	Temperature: 85°C Humidity:85% Time:168H
Pressure cooker Test	Temperature: 121°C , 2atm. Humidity:100% Time:24H
Resistance of soldering heat	Temperature: $260 \pm 5^\circ\text{C}$ Time of dip soldering: 10s, 3times

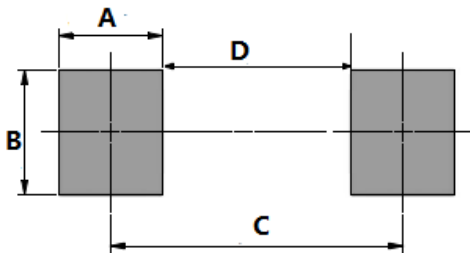
Note: The above testing items can be specified by customer's special request

Product Dimensions



REF	mm	inch
A	0.700-0.900	0.028-0.035
A1	<0.200	<0.008
A2	0.250-0.350	0.010-0.014
A3	1.100-1.300	0.043-0.051
D	1.500-1.700	0.059-0.067
E	0.500-0.700	0.020-0.028
F	0.200-0.300	0.008-0.012

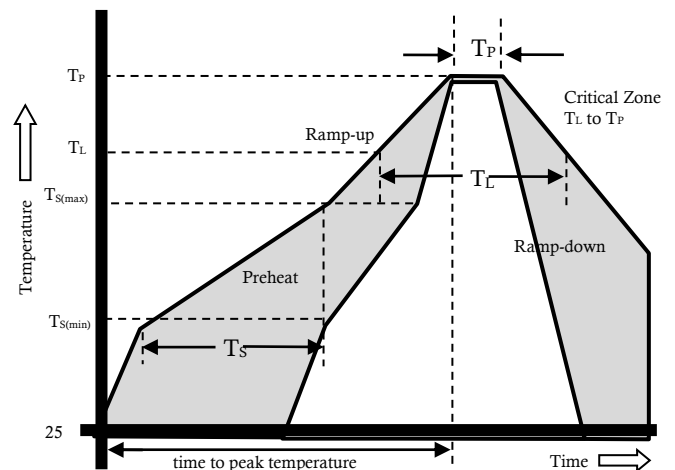
Recommended Soldering Pad



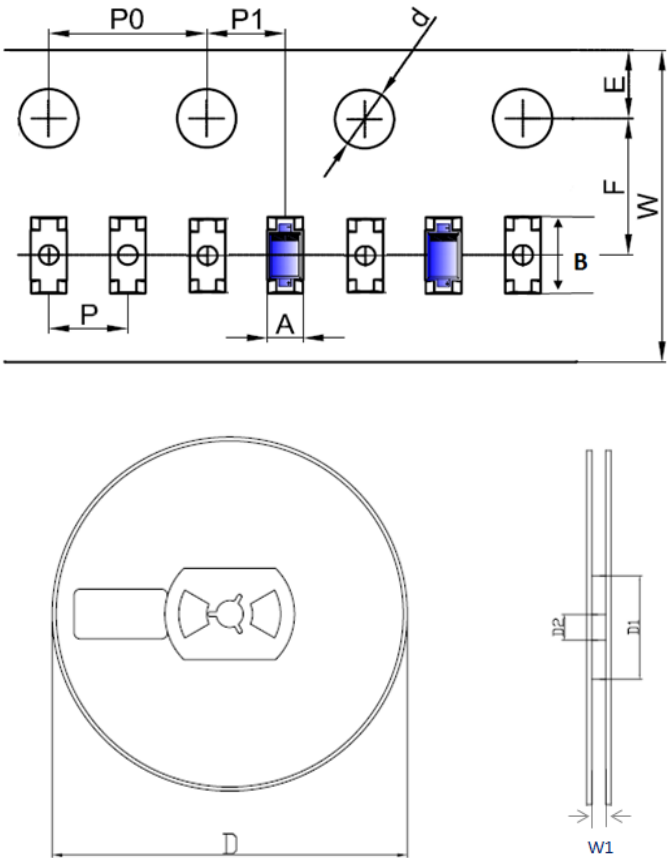
REF	mm	inch
A	0.5	0.020
B	0.6	0.024
C	1.42	0.056
D	0.92BSC	0.036

Reflow Profile

Reflow Condition		Pb-Free assembly
Pre Heat	Temperature Min	150°C
	Temperature Max	200°C
	Time (Min to Max)	60 – 180 secs
Average ramp up rate (Liquid) T _{amp} (T _L) to peak		3°C/s Max
T _S (max) to T _L - Ramp-up Rate		3°C/s Max
Reflow	- Temperature (T _L) (Liquid)	217°C
	- Temperature (T _L)	60 – 150 secs
Peak Temperature (T _P)		260+0/-5 °C
Time within 5°C of actual peak Temperature (T _P)		30secs
Ramp-down Rate		6°C/s Max
Time 25°C to peak Temperature (T _P)		8 mins Max.
Do not exceed		260°C



Package Reel Information



REF	mm	inch
A	0.95+/-0.10	0.037+/-0.004
B	1.95+/-0.10	0.077+/-0.004
d	1.50+0.1/-0	0.059+0.004/-0
D	178.00+/-2.00	7.008+/-0.079
D1	55.00+/-3.00	2.165+/-0.118
D2	13.00+/-0.50	0.512+/-0.020
E	1.75+/-0.10	0.069+/-0.004
F	3.50+/-0.20	0.138+/-0.008
P	2.00+/-0.20	0.079+/-0.008
P0	4.00+/-0.20	0.157+/-0.008
P1	2.00+/-0.20	0.079+/-0.008
W	8.00+/-0.20	0.315+/-0.008
W1	8.60+/-1.00	0.339+/-0.039

OUTLINE	REEL (PCS)	PER CARTON (PCS)	REEL DIAMETERS (mm)	CARTON SIZE(mm)		
				L	W	H
TAPING	3,000	90,000	178	390	370	220